

## LM567/LM567C Tone Decoder

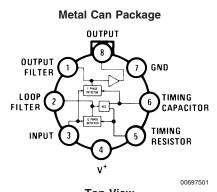
## **General Description**

The LM567 and LM567C are general purpose tone decoders designed to provide a saturated transistor switch to ground when an input signal is present within the passband. The circuit consists of an I and Q detector driven by a voltage controlled oscillator which determines the center frequency of the decoder. External components are used to independently set center frequency, bandwidth and output delay.

## Features

- 20 to 1 frequency range with an external resistor
- Logic compatible output with 100 mA current sinking capability
- Bandwidth adjustable from 0 to 14%

## **Connection Diagrams**

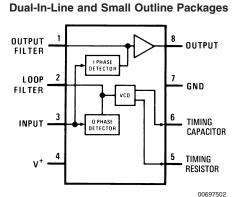


Top View Order Number LM567H or LM567CH See NS Package Number H08C High rejection of out of band signals and noise

- Immunity to false signals
- Highly stable center frequency
- Center frequency adjustable from 0.01 Hz to 500 kHz

### Applications

- Touch tone decoding
- Precision oscillator
- Frequency monitoring and control
- Wide band FSK demodulation
- Ultrasonic controls
- Carrier current remote controls
- Communications paging decoders



Top View Order Number LM567CM See NS Package Number M08A Order Number LM567CN See NS Package Number N08E

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#### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage Pin	9V
Power Dissipation (Note 2)	1100 mW
V <sub>8</sub>	15V
V <sub>3</sub>	-10V
V <sub>3</sub>	$V_4 + 0.5V$
Storage Temperature Range	–65°C to +150°C
Operating Temperature Range	

LM567H	–55°C to +125°C
LM567CH, LM567CM, LM567CN	0°C to +70°C
Soldering Information	
Dual-In-Line Package	
Soldering (10 sec.)	260°C
Small Outline Package	
Vapor Phase (60 sec.)	215°C
Infrared (15 sec.)	220°C
See AN-450 "Surface Mounting Method	ls and Their Effect

on Product Reliability" for other methods of soldering surface mount devices.

## **Electrical Characteristics**

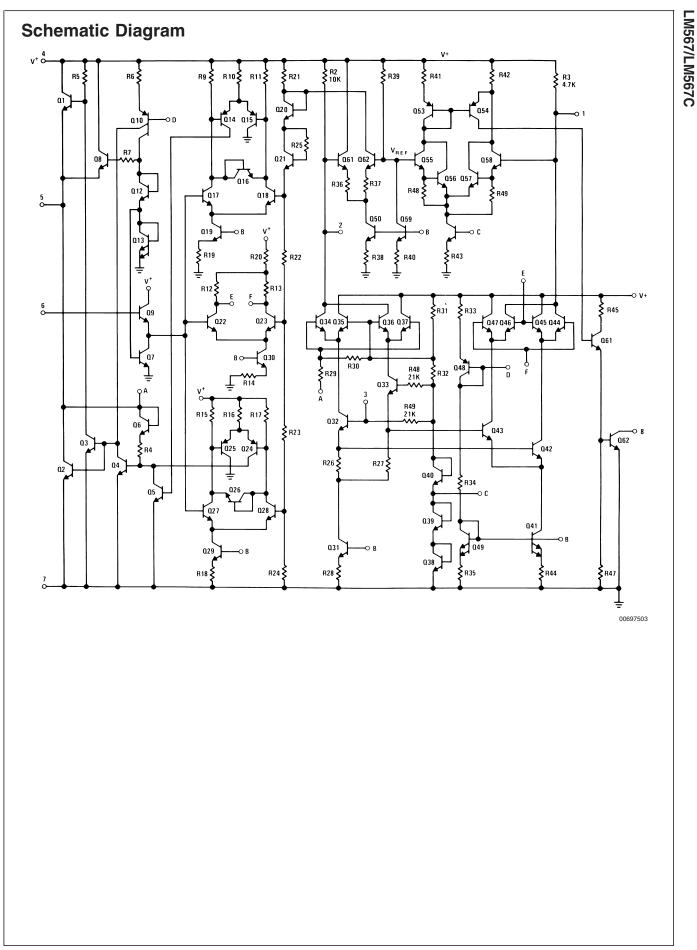
AC Test Circuit,  $T_A = 25^{\circ}C$ ,  $V^+ = 5V$ 

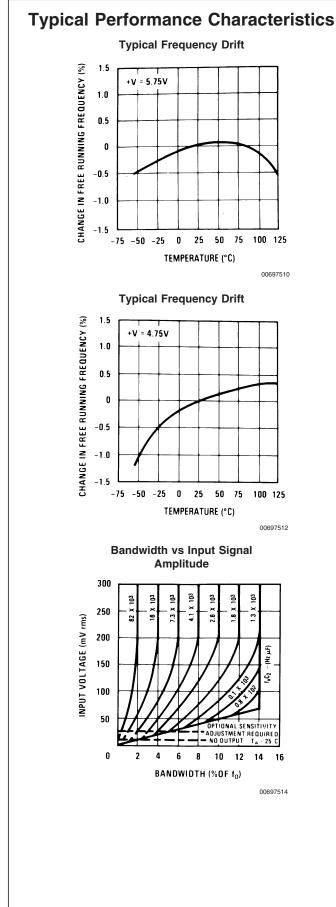
Devenuetore	Conditions	LM567			LM567C/LM567CM			
Parameters	Conditions	Min	Тур	Max	Min	Тур	Max	Units
Power Supply Voltage Range		4.75	5.0	9.0	4.75	5.0	9.0	V
Power Supply Current Quiescent	$R_L = 20k$		6	8		7	10	mA
Power Supply Current Activated	$R_L = 20k$		11	13		12	15	mA
Input Resistance		18	20		15	20		kΩ
Smallest Detectable Input Voltage	$I_{L} = 100 \text{ mA}, f_{i} = f_{o}$		20	25		20	25	mVrms
Largest No Output Input Voltage	$I_{\rm C} = 100 \text{ mA}, f_{\rm i} = f_{\rm o}$	10	15		10	15		mVrms
Largest Simultaneous Outband Signal to Inband Signal Ratio			6			6		dB
Minimum Input Signal to Wideband Noise Ratio	B <sub>n</sub> = 140 kHz		-6			-6		dB
Largest Detection Bandwidth		12	14	16	10	14	18	% of f <sub>o</sub>
Largest Detection Bandwidth Skew			1	2		2	3	% of $f_o$
Largest Detection Bandwidth Variation with Temperature			±0.1			±0.1		%/°C
Largest Detection Bandwidth Variation with Supply Voltage	4.75-6.75V		±1	±2		±1	±5	%V
Highest Center Frequency		100	500		100	500		kHz
Center Frequency Stability (4.75-5.75V)	$0 < T_A < 70$ -55 < $T_A < +125$		35 ± 60 35 ± 140			$35 \pm 60$ $35 \pm 140$		ppm/°C ppm/°C
Center Frequency Shift with Supply Voltage	4.75V-6.75V 4.75V-9V		0.5	1.0 2.0		0.4	2.0 2.0	%/V %/V
Fastest ON-OFF Cycling Rate			f <sub>o</sub> /20			f <sub>o</sub> /20		
Output Leakage Current	V <sub>8</sub> = 15V		0.01	25		0.01	25	μA
Output Saturation Voltage	$e_i = 25 \text{ mV}, I_8 = 30 \text{ mA}$		0.2	0.4		0.2	0.4	V
	e <sub>i</sub> = 25 mV, I <sub>8</sub> = 100 mA		0.6	1.0		0.6	1.0	
Output Fall Time			30			30		ns
Output Rise Time			150			150		ns

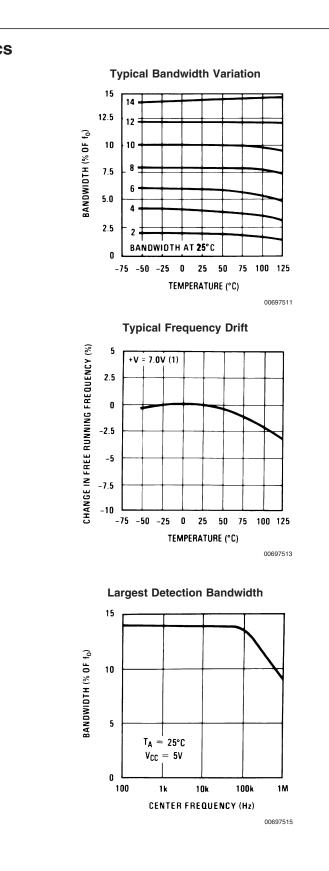
**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

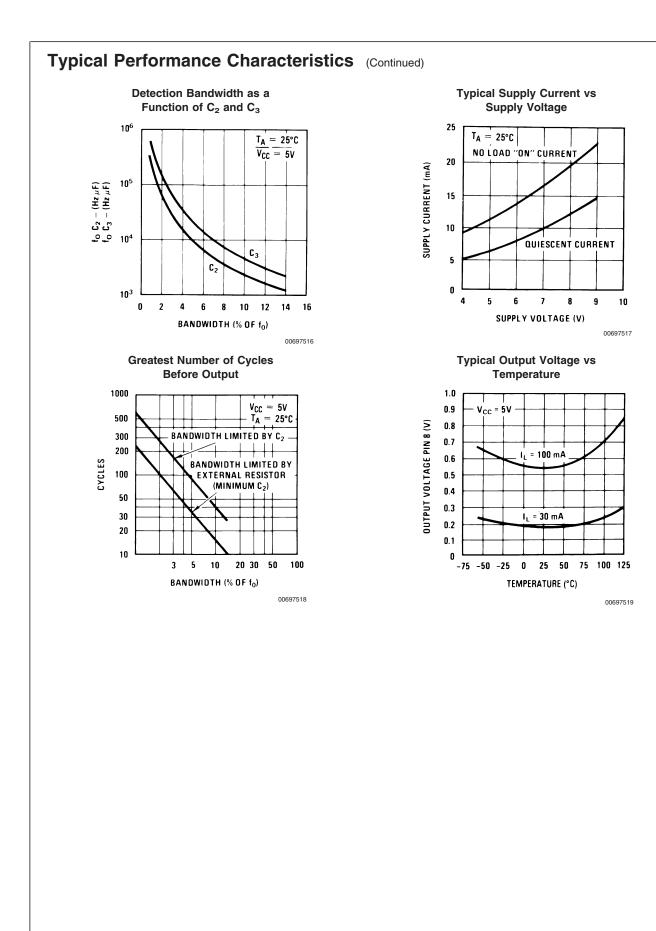
Note 2: The maximum junction temperature of the LM567 and LM567C is 150°C. For operating at elevated temperatures, devices in the TO-5 package must be derated based on a thermal resistance of 150°C/W, junction to ambient or 45°C/W, junction to case. For the DIP the device must be derated based on a thermal resistance of 110°C/W, junction to ambient. For the Small Outline package, the device must be derated based on a thermal resistance of 160°C/W, junction to ambient.

Note 3: Refer to RETS567X drawing for specifications of military LM567H version.

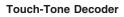


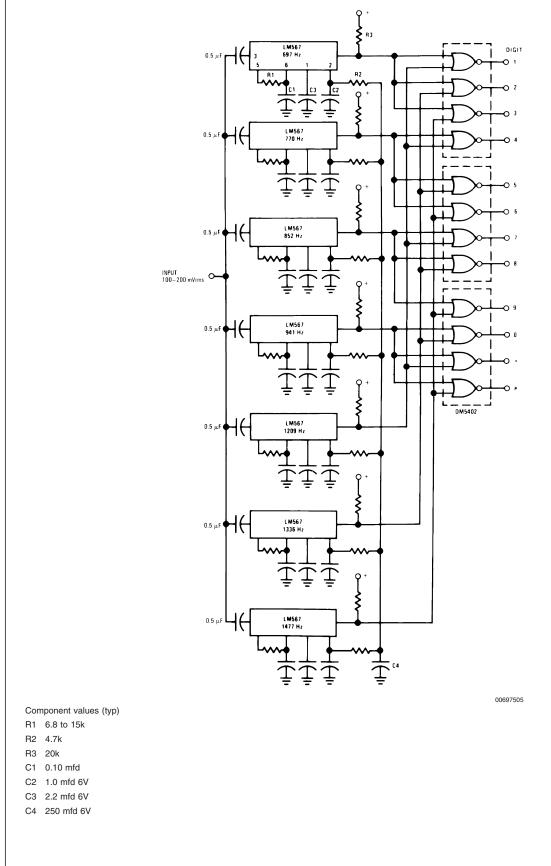


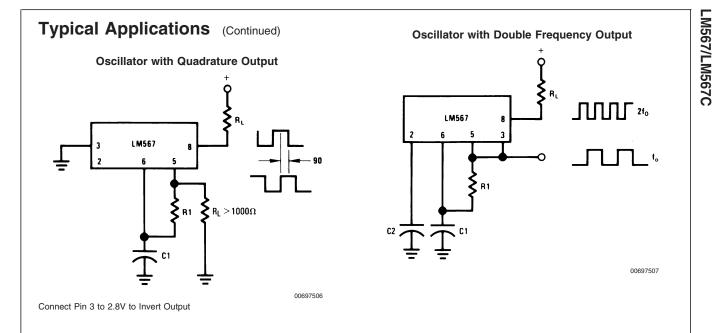


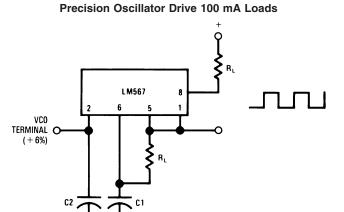


## **Typical Applications**



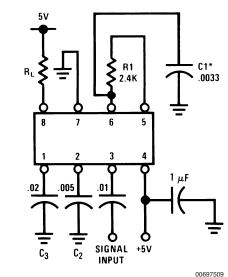






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### **AC Test Circuit**



 $\label{eq:states} \begin{array}{l} f_i = 100 \mbox{ kHz} + 5V \\ \mbox{*Note: Adjust for } f_o = 100 \mbox{ kHz}. \end{array}$ 

### **Applications Information**

The center frequency of the tone decoder is equal to the free running frequency of the VCO. This is given by

$$f_o \cong \frac{1}{1.1 R_1 C_1}$$

The bandwidth of the filter may be found from the approximation

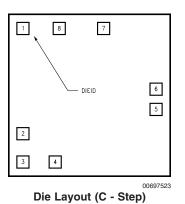
BW = 1070 
$$\sqrt{\frac{V_i}{f_o C_2}}$$
 in % of  $f_o$ 

Where:

 $V_i$  = Input voltage (volts rms),  $V_i \le 200 \text{mV}$ 

 $C_2$  = Capacitance at Pin 2(µF)

## LM567C MDC MWC TONE DECODER



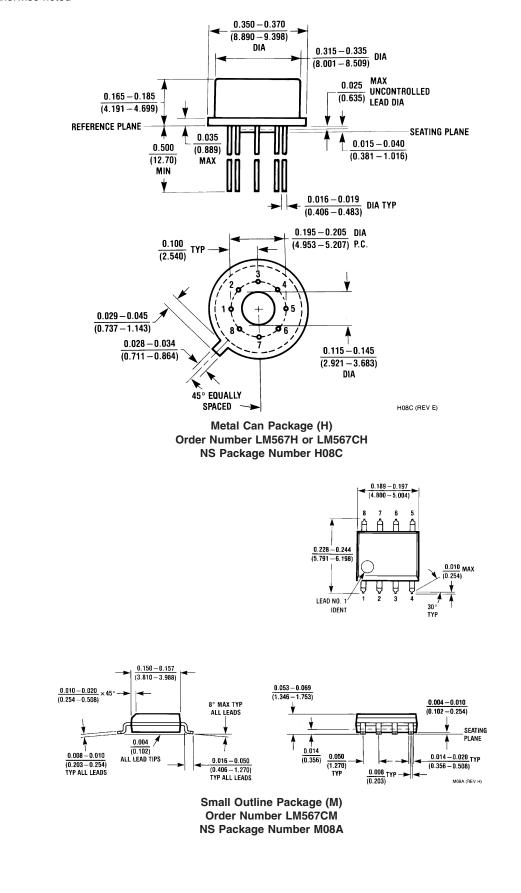
## **DIE/WAFER CHARACTERISTICS**

Fabrication Attributes			General Die Information						
Physical Die Ider	vsical Die Identification LM567C		Bond Pad Opening Size (min)			91µm x 91µm			
Die Step		С		Bond Pad Metalization		0.	0.5% COPPER_BAL.		
						A	LUMINUM		
Physical Attributes		Passivation			VOM NITRIDE				
Wafer Diameter	fer Diameter 150mm			Back Side Metal			BARE BACK		
Dise Size (Drawr	ו)	1600µm x	1626µm	Back Side Connection		FI	Floating		
		63.0mils x	64.0mils						
Thickness		406µm No	ominal						
Min Pitch		198µm No	ominal						
Special Assem	bly Requirements:								
Note: Actual die size is rounded to the nearest micron.									
Die Bond Pad Coordinate Locations (C - Step)									
(Referenced to die center, coordinates in µm) NC = No Connection, N.U. = Not Used									
SIGNAL NAME PAD# NUMBER		X/Y COO	X/Y COORDINATE			PAD SIZE	SIZE		
SIGNAL NAME	PAD# NUMBER	Х		Y	Х		Y		
OUTPUT	1	-673	6	86	91	х	91		
FILTER									
LOOP FILTER	2	-673	-4	19	91	х	91		
INPUT	3	-673	-673 -68		91	x	91		
V+	4	-356	-356 -6		91	х	91		
TIMING RES	5	673	673 -1		91	х	91		
TIMING CAP	6	673	8 7		91	х	91		
GND	7	178	6	86	117	х	91		
OUTPUT	8	-318	6	79	117	х	104		

## LM567C MDC MWC TONE DECODER (Continued)

IN U.S.A	
Tel #:	1 877 Dial Die 1 877 342 5343
Fax:	1 207 541 6140
IN EUROPE	
Tel:	49 (0) 8141 351492 / 1495
Fax:	49 (0) 8141 351470
IN ASIA PACIFIC	
Tel:	(852) 27371701
IN JAPAN	
Tel:	81 043 299 2308

## Physical Dimensions inches (millimeters) unless otherwise noted



LM567/LM567C

